



Knowledge in Process

For Immediate Release

Speedline's Electrovert OmniMax™ Reflow Soldering System Receives New Product Introduction Award

CAMDENTON, MO – April 7, 2010 – Circuits Assembly magazine presented Speedline Technologies with the 2010 New Product Introduction Award during ceremonies held at the IPC APEX® trade event in Las Vegas on April 6. The award was presented in the reflow soldering category for the new Electrovert OmniMax. Winners were honored for their innovation, compatibility, cost-effectiveness, design, speed/throughput improvements, ease-of-use, maintainability and repairability.



As high reliability SMT PCB's become more complex and process windows continue to decrease, manufacturers are looking for technologies that improve product reliability, reduce costs associated with rework or scrap, reduce operating costs, and still provide the levels of throughput from an in-line reflow oven. The Electrovert OmniMax is designed to address these issues and provide a cost-effective, reliable solution.

According to Greg Calvo, Electrovert reflow product manager, "Our product development team worked diligently to ensure that consistent thermal capability and control were key design drivers in the OmniMax. A dual IsoThermal™ chamber approach is used that produces ΔT 's less than +/- 2°C within 7 and 10 zone ovens (air or nitrogen). The introduction of an industry-first patent-pending dripless cooling feature in the OmniMax extends maintenance intervals in the cooling section. Excellent separation between the heating and cooling zones and lower nitrogen consumption are additional benefits of the OmniMax. We are very pleased to have our efforts recognized with the NPI Award and we look forward to continued success with this product."

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About Speedline Technologies

Speedline Technologies is the global leader in process knowledge, services and manufacture of capital equipment used in printed circuit board assembly and semiconductor industries. Based in Franklin, Massachusetts, USA, the company markets five best-in-class brands: Accel microelectronics cleaning equipment; Camalot dispensing systems; Electrovert wave soldering, reflow soldering and cleaning equipment; MPM stencil and screen printing systems; and Protect global services, support and training solutions.

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